MSKSEMI















ESD

TVS

TSS

MOV

GDT

PLED

Broduct data sheet



Features

Ideal for printed circuit board

Reliable low cost construction utilizing molded plastic technique

High temperature soldering guaranteed: 260°/10 seconds at 5

lbs., (2.3kg) tension

Small size, simple installation

High surge current capability

.335(8.50) .397(7.8) .35(8.50) .397(7.8) .35(8.50) .307(7.8) .35(8.50) .307(7.8) .35(8.50) .307(7.8) .307(7.8) .35(8.50) .307(7.8) .307(7.8) .307(7.8) .308(0.20) .008(0.20) .008(0.20) .008(0.20) .008(0.20) .008(0.20) .008(0.20) .008(0.20) .008(0.20) .008(0.20) .008(0.20) .008(0.20) .008(0.20)

Dimensions in inches and (millimeters)

Mechanical Data

Case: JEDEC DBS Molded plastic body

Terminals: Solder plated, solderable per MIL-STD-750, Method

2026

Polarity: Polarity symbol marking on case

Mounting Position : Any

Weight: 0.02 ounce, 0.4 grams

REEL SPECIFICATION

P/N	PKG	QTY
DB101S-DB107S	DBS	1500

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwisespecified.

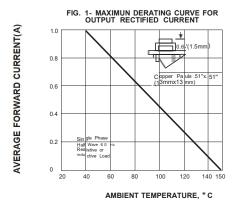
Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

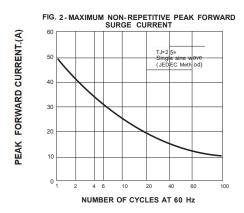
Parameter	SYMBOLS	DD4040	DB102S	DB103S	DB104S	DB105S	DB106S	DB107S	UNITS
Marking Code		DB101S							
Maximum repetitive peak reverse voltage	Vrrm	50	100	200	400	600	800	1000	V
Maximum RMS voltage		35	70	140	280	420	560	700	V
Maximum DC blocking voltage		50	100	200	400	600	800	1000	V
Maximum average forward rectified current at Tc=40°C		1.0						Α	
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)		50						А	
Maximum instantaneous forward voltage drop per leg at 1A		1.1						V	
Maximum DC reverse current T _A =25°C at rated DC blocking voltage T _A =100°C	lR	10 500				μA μA			
Operating temperature range		-55 to +150						°C	
storage temperature range		-55 to +150						°C	

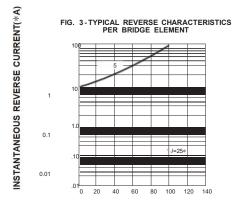
NOTES:DBS for surface mount package.



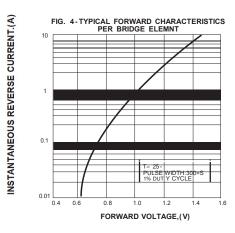
atings And Characteristic Curves

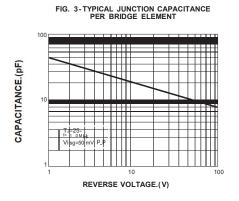
















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